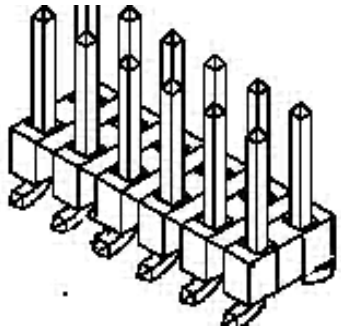
Part Number : 877592015
Product Description : Milli-Grid Header, Surface Mount, Vertical, 20 Circuits, 0.76µm Gold (Au) Selective Plating, without Press-fit Plastic Pegs, Lead-Free
Series Number : 87759
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

877592015_sd.pdf

PK-89990-475-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

503940001-AS-000.pdf

PS-87761-100-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	87759
Description	Milli-Grid Header, Surface Mount, Vertical, 20 Circuits, 0.76µm Gold (Au) Selective Plating, without Press-fit Plastic Pegs, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Header
Product Name	Milli-Grid
UPC	822348311415

Agency

UL	E29179

Electrical

Current - Maximum per Contact	2.0A
Voltage - Maximum	125V

Physical

Breakaway	Yes
Circuits (Loaded)	20
Circuits (maximum)	20
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Mated Height	3.80mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.495/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	None
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.762µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	Yes
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	REFLOW

Max-Cycle	3
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Milli-Grid Dual Row Receptacle Housings	51110
Milli-Grid Vertical Through Hole PCB Receptacles	78787
Milli-Grid Top Entry Surface Mount PCB Receptacles	78788
Milli-Grid Vertical Through Hole PCB Receptacles	79107
Milli-Grid Vertical Through Hole PCB Receptacles	79108
Milli-Grid Top/Bottom Entry Surface Mount PCB Receptacles	79109
Milli-Grid Top Entry Surface Mount PCB Receptacles	87381